

KSE800/801/802/803

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Monolithic Construction With Built-in Base-Emitter Resistors

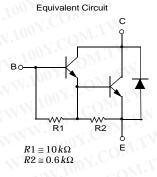
- High DC Current Gain: h_{FE}= 750 (Min.) @ IC= 1.5 and 2.0A DC
- Complement to KSE700/701/702/703



NPN Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Paramete	r ov Com	√ Value	Units
V _{CBO}	Collector- Base Voltage	: KSE800/801 : KSE802/803	60 80	V
V _{CEO}	Collector-Emitter Voltage	: KSE802/803 : KSE802/803	60 80	V
V _{EBO}	Emitter-Base Voltage	100X.CO	5	V
Ic	Collector Current	MAN CO	4	Α
I _B V 100	Base Current	M.100	0.1	Α
P _C	Collector Dissipation (T _C =25°C)		40	W
Tj	Junction Temperature		150	°C
T _{STG}	Storage Temperature		- 55 ~ 150	√ °C



Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage : KSE800/801 : KSE802/803	I _C = 50mA, I _B = 0	60 80	W.100	V
I _{CEO}	Collector Cut-off Current : KSE800/801 : KSE802/803	$V_{CE} = 60V, I_{B} = 0$ $V_{CE} = 80V, I_{B} = 0$	W	100 100	μΑ μΑ
I _{CBO}	Collector Cut-off Current	V_{CB} = Rated BV_{CEO} , I_E = 0 V_{CB} = Rated BV_{CEO} , I_E = 0 T_C = 100°C		100 500	μA μA
I _{EBO}	Emitter Cut-off Current	$V_{BE} = 5V, I_{C} = 0$	6 T	2	mA
h _{FE}	DC Current Gain : KSE800/802 : KSE801/803 : ALL DEVICES	$V_{CE} = 3V, I_C = 1.5A$ $V_{CE} = 3V, I_C = 2A$ $V_{CE} = 3V, I_C = 4A$	750 750 100	W	NW.1
V _{CE} (sat)	Collector-Emitter Saturation Voltage : KSE800/802 : KSE801/803 : ALL DEVICES	$I_C = 1.5A, I_B = 30mA$ $I_C = 2A, I_B = 40mA$ $I_C = 4A, I_B = 40mA$	LIN	2.5 2.8 3	V V V
V _{BE} (on)	Base-Emitter ON Voltage : KSE800/802 : KSE801/803 : ALL DEVICES	$V_{CE} = 3V, I_{C} = 1.5A$ $V_{CE} = 3V, I_{C} = 2A$ $V_{CE} = 3V, I_{C} = 4A$	M.TV OM.TV	2.5 2.5 3	V V V

Typical Characteristics

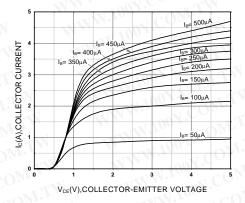


Figure 1. Static Characteristic

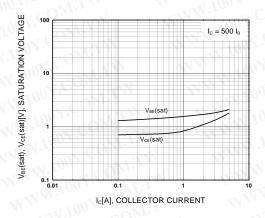


Figure 3. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

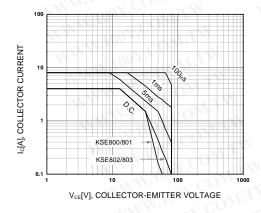


Figure 5. Safe Operating Area

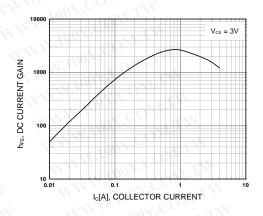


Figure 2. DC current Gain

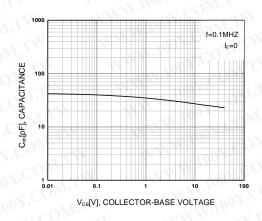


Figure 4. Collector Output Capacitance

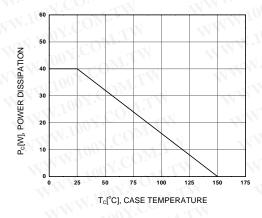


Figure 6. Power Derating

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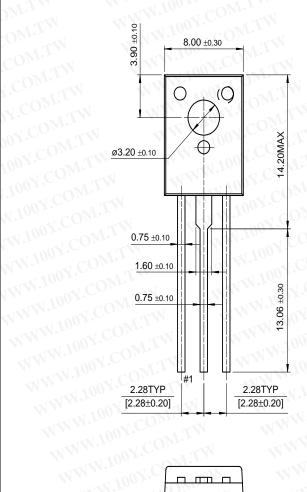
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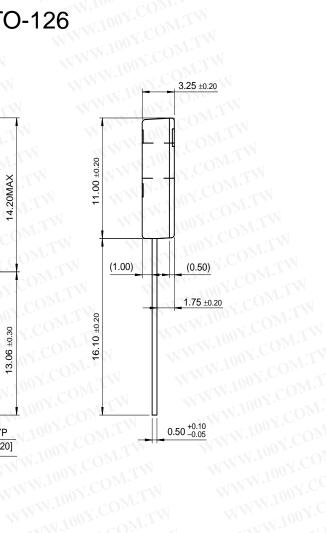
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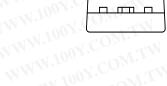
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